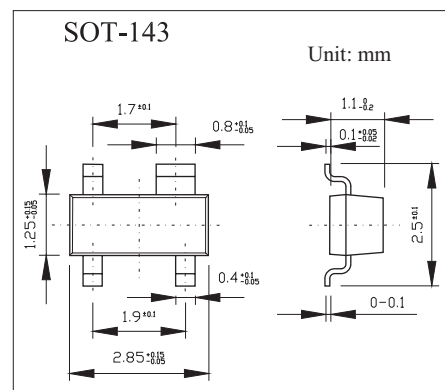


Silicon RF Switching Diodes

BAR81

■ Features

- Design for use in shunt configuration
- High shunt signal isolation
- Low shunt insertion loss

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Value	Unit
Diode reverse voltage	V_R	30	V
Forward current	I_F	100	mA
Junction temperature	T_j	150	$^\circ\text{C}$
Operating temperature range	T_{op}	-55 to +125	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

■ Electrical Characteristics $T_a = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Reverse current	I_R	$V_R = 20\text{ V}$			20	nA
Forward voltage	V_F	$I_F = 100\text{ mA}$		0.93	1	V
Diode capacitance	C_T	$V_R = 1\text{ V}, f = 1\text{ MHz}$		0.6		pF
		$V_R = 3\text{ V}, f = 1\text{ MHz}$		0.57		
Forward resistance	r_f	$I_F = 5\text{ mA}, f = 100\text{ MHz}$		0.7		Ω
Series inductance chip to ground	L_s			1.5		nH

■ Marking

Type	BAR81
Marking	BBs